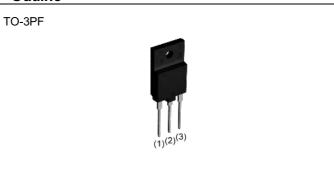


| V <sub>DSS</sub>           | 650V   |
|----------------------------|--------|
| R <sub>DS(on)</sub> (Max.) | 0.185Ω |
| Ι <sub>D</sub>             | ±24A   |
| P <sub>D</sub>             | 74W    |

#### Outline



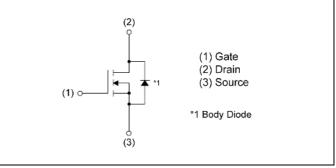
#### Inner circuit



Application

Switching

- 1) Low on-resistance
- 2) Fast switching speed
- 3) Parallel use is easy
- 4) Pb-free plating ; RoHS compliant



## Packaging specifications

| Packing        | Tube     |
|----------------|----------|
| Packing code   | C17      |
| Marking        | R6524ENZ |
| Quantity (pcs) | 300      |
|                |          |

## • Absolute maximum ratings (T<sub>a</sub> = 25°C ,unless otherwise specified)

| Parameter                               | Symbol           | Value              | Unit |    |
|---|------------------|--------------------|------|----|
| Drain - Source voltage                  |                  | V <sub>DSS</sub>   | 650  | V  |
| Continuous drain current ( $T_c = 25$   | 5°C)             | ۱ <sub>D</sub> *1  | ±24  | А  |
| Pulsed drain current                    |                  | $I_{DP}^{*2}$      | ±72  | А  |
| Octo Octores to the me                  | static           | M                  | ±20  | V  |
| Gate - Source voltage                   | AC(f>1Hz)        | V <sub>GSS</sub>   | ±30  | V  |
| Avalanche current, single pulse         | ·                | I <sub>AS</sub>    | 4.1  | А  |
| Avalanche energy, single pulse          |                  | E <sub>AS</sub> *3 | 654  | mJ |
| Power dissipation $(T_c = 25^{\circ}C)$ | P <sub>D</sub>   | 74                 | W    |    |
| Junction temperature                    | Tj               | 150                | °C   |    |
| Operating junction and storage te       | T <sub>stg</sub> | -55 to +150        | °C   |    |

#### •Thermal resistance

| Deremeter                                    | Cumph of          | Values |      |      | Lincit |
|--|-------------------|--------|------|------|--------|
| Parameter                                    | Symbol            | Min.   | Тур. | Max. | Unit   |
| Thermal resistance, junction - case          | $R_{thJC}^{*4}$   | -      | -    | 1.7  | °C/W   |
| Thermal resistance, junction - ambient       | R <sub>thJA</sub> | -      | -    | 40   | °C/W   |
| Soldering temperature, wavesoldering for 10s | T <sub>sold</sub> | -      | -    | 265  | °C     |

# •Electrical characteristics (T<sub>a</sub> = 25°C)

| Parameter                                      | Sumbol                                 | Conditions                                    | Values |       |       | Unit |  |
|--|--|---|--------|-------|-------|------|--|
|  | Symbol                                 | Conditions                                    | Min.   | Тур.  | Max.  | Onit |  |
| Drain - Source breakdown<br>voltage            | $V_{(BR)DSS}$ $V_{GS} = 0V, I_D = 1mA$ |   | 650    | -     | -     | V    |  |
|  |  | V <sub>DS</sub> = 650V, V <sub>GS</sub> = 0V  |        |       |       |      |  |
| Zero gate voltage<br>drain current             | I <sub>DSS</sub>                       | $T_j = 25^{\circ}C$                           | -      | -     | 100   | μA   |  |
|  |  | T <sub>j</sub> = 125°C                        | -      | -     | 1000  |      |  |
| Gate - Source leakage current                  | I <sub>GSS</sub>                       | $V_{GS}$ = ±20V, $V_{DS}$ = 0V                | -      | -     | ±100  | nA   |  |
| Gate threshold voltage                         | $V_{GS(th)}$                           | $V_{DS}$ = $V_{GS}$ , $I_D$ = 750 $\mu$ A     | 2      | -     | 4     | V    |  |
|  |  | V <sub>GS</sub> = 10V, I <sub>D</sub> = 11.3A |        |       |       |      |  |
| Static drain - source<br>on - state resistance | $R_{DS(on)}^{*5}$                      | $T_j = 25^{\circ}C$                           | -      | 0.160 | 0.185 | Ω    |  |
|  |  | $T_j = 125^{\circ}C$                          | -      | 0.340 | -     |      |  |
| Gate resistance                                | R <sub>G</sub>                         | f = 1MHz, open drain                          | -      | 6.5   | -     | Ω    |  |



## • Electrical characteristics (T<sub>a</sub> = 25°C)

| Deremeter                    | Curren el                             | Conditions                            | Values |      |      | Linit |  |
|------------------------------|---------------------------------------|---------------------------------------|--------|------|------|-------|--|
| Parameter                    | Symbol Conditions                     |                                       | Min.   | Тур. | Max. | Unit  |  |
| Input capacitance            | C <sub>iss</sub> V <sub>GS</sub> = 0V |                                       | -      | 1650 | -    |       |  |
| Output capacitance           | C <sub>oss</sub>                      | V <sub>DS</sub> = 25V                 | -      | 1850 | -    | pF    |  |
| Reverse transfer capacitance | C <sub>rss</sub>                      | f = 1MHz                              | -      | 220  | -    |       |  |
| Turn - on delay time         | t <sub>d(on)</sub> *5                 | $V_{DD} \simeq 300$ V, $V_{GS}$ = 10V | -      | 30   | -    |       |  |
| Rise time                    | t <sub>r</sub> *5                     | I <sub>D</sub> = 12A                  | -      | 55   | -    | 20    |  |
| Turn - off delay time        | $t_{d(off)}$ *5                       | $R_L \simeq 27.4\Omega$               | -      | 180  | -    | ns    |  |
| Fall time                    | t <sub>f</sub> *⁵                     | R <sub>G</sub> = 10Ω                  | -      | 55   | -    |       |  |

## • Gate charge characteristics ( $T_a = 25^{\circ}C$ )

| Deremeter            | Currence al            | Conditions                                  | Values |      |      | Unit |
|----------------------|------------------------|---|--------|------|------|------|
| Parameter            | Symbol Conditions      |   | Min.   | Тур. | Max. | Unit |
| Total gate charge    | $Q_g^{*5}$             | $V_{DD} \simeq 300 V$                       | -      | 70   | -    |      |
| Gate - Source charge | Q <sub>gs</sub> *5     | I <sub>D</sub> = 24A                        | -      | 10   | -    | nC   |
| Gate - Drain charge  | Q <sub>gd</sub> *5     | V <sub>GS</sub> = 10V                       | -      | 35   | -    |      |
| Gate plateau voltage | V <sub>(plateau)</sub> | $V_{DD} \simeq 300$ V, I <sub>D</sub> = 24A | -      | 6.4  | -    | V    |

\*1 Limited only by maximum channel temperature allowed.

\*2 Pw  $\leq$  10µs, Duty cycle  $\leq$  1%

\*3 L $\doteqdot$ 70mH, V<sub>DD</sub>=50V, R<sub>G</sub>=25 $\Omega$ , STARTING T<sub>j</sub>=25°C

\*4 T<sub>C</sub>=25°C

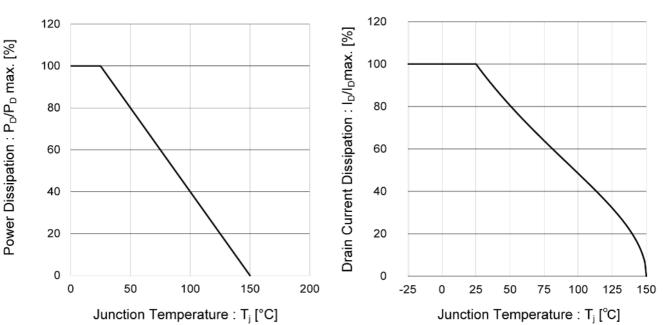
\*5 Pulsed



## •Body diode electrical characteristics (Source-Drain) (T<sub>a</sub> = 25°C)

| Parameter   | Symbol             | Conditions                                 | Values |      |      | Unit |
|---|--------------------|--|--------|------|------|------|
| Farameter   | Symbol             | Conditions                                 | Min.   | Тур. | Max. | Unit |
| Source current  | I <sub>S</sub> *1  |  | -      | -    | 24   | А    |
| Pulsed source current                                   | $I_{SP}^{*2}$      | T <sub>C</sub> = 25°C                      | -      | -    | 72   | А    |
| Source-Drain voltage $V_{SD}^{*5}$ $V_{GS} = 0V, I_S =$ |                    | V <sub>GS</sub> = 0V, I <sub>S</sub> = 24A | -      | -    | 1.5  | V    |
| Reverse recovery time                                   | t <sub>rr</sub> *5 |  | -      | 540  | -    | ns   |
| Reverse recovery charge                                 | Q <sub>rr</sub> *5 | I <sub>S</sub> = 24A<br>di/dt = 100A/µs    | -      | 9.5  | -    | μC   |
| Peak reverse recovery current                           | ۱ <sub>.۳</sub> *5 |  | -      | 35   | -    | А    |





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Fig.1 Power Dissipation Derating Curve



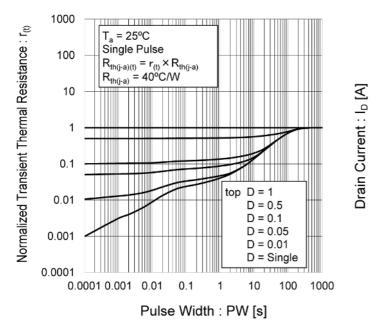
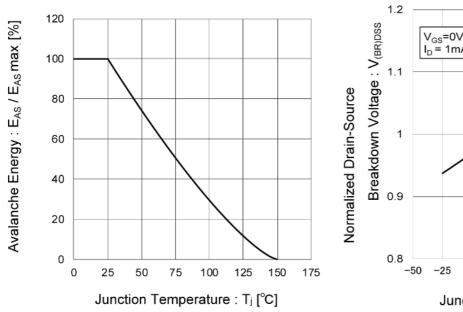


Fig.3 Normalized Transient Thermal

Resistance vs. Pulse Width

100 ration in this are imited by R<sub>DS(on)</sub> ( V<sub>GS</sub> = 10V ) 10 = 100µs w 1  $P_{W} = 1ms$  $P_w = 10 ms$ 0.1 T<sub>a</sub>=25°C Single Pulse 0.01 10 100 1000 0.1 1 Drain - Source Voltage : V<sub>DS</sub> [V]





## Fig.5 Avalanche Energy Derating Curve vs. Junction Temperature

Fig.6 Normalized Breakdown Voltage vs. Junction Temperature

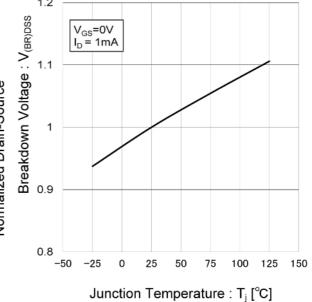
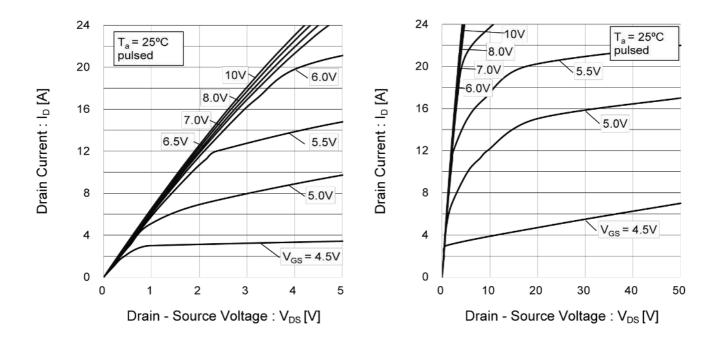
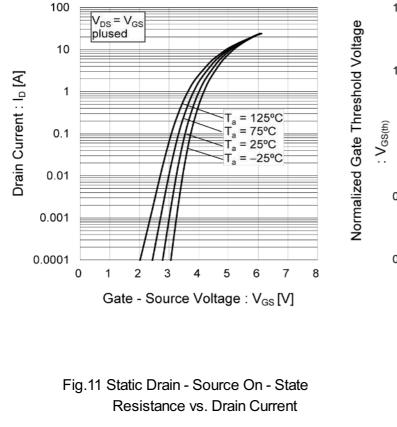


Fig.7 Typical Output Characteristics(I)

Fig.8 Typical Output Characteristics(II)





## Fig.9 Typical Transfer Characteristics

Fig.10 Normalized Gate Threshold . Voltage vs Junction Temperature

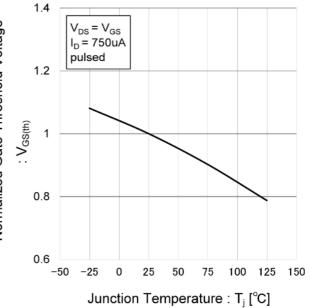
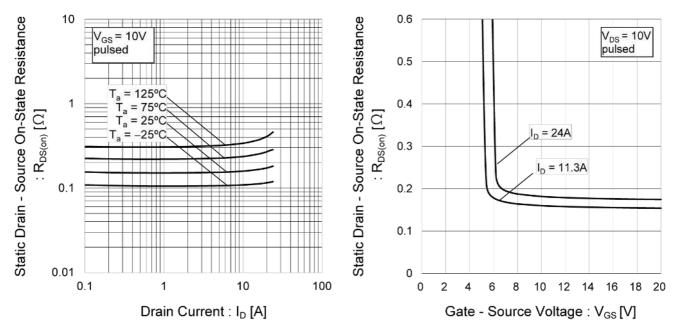


Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage





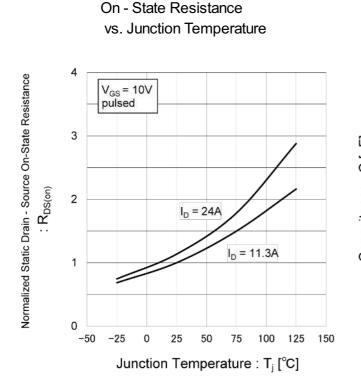


Fig.13 Normalized Static Drain - Source

Fig.14 Typical Capacitance vs. Drain - Source Voltage

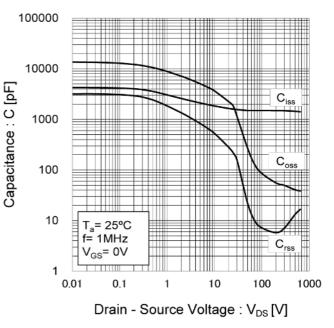
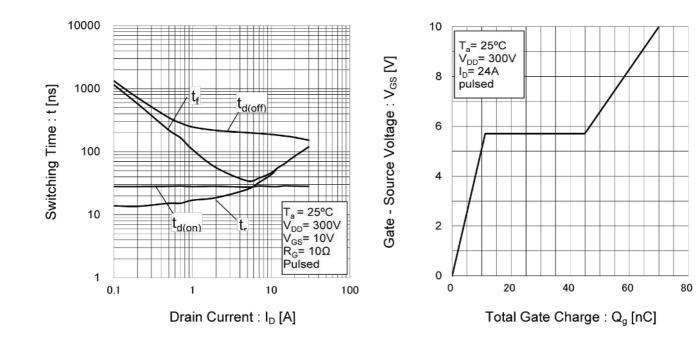


Fig.15 Switching Characteristics

Fig.16 Typical Gate Charge

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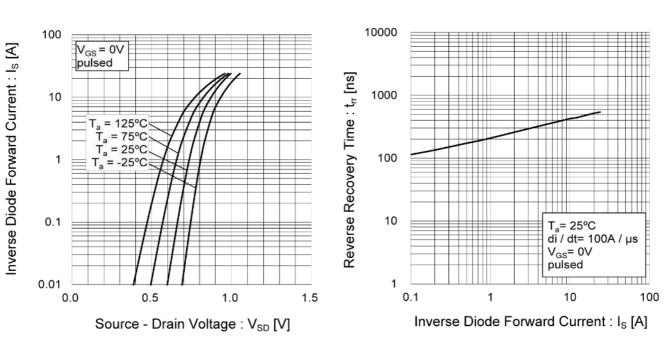


Fig.17 Source Current vs. Source - Drain Voltage Fig.18 Reverse Recovery Time vs. Inverse Diode Forward Current



#### Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

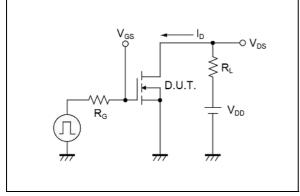
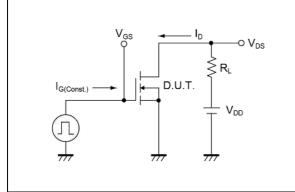


Fig.2-1 Gate Charge Measurement Circuit



#### Fig.3-1 Avalanche Measurement Circuit

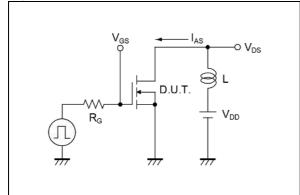


Fig.4-1 trr Measurement Circuit

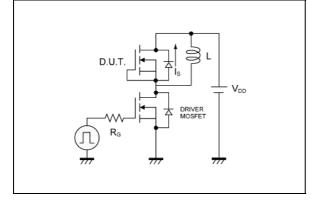
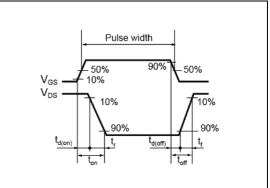
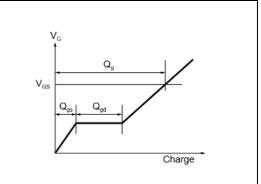


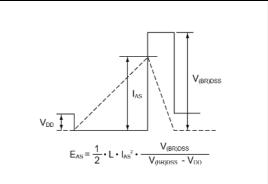
Fig.1-2 Switching Waveforms



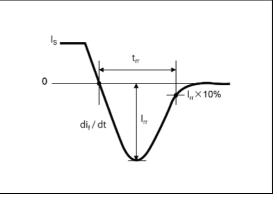
#### Fig.2-2 Gate Charge Waveform



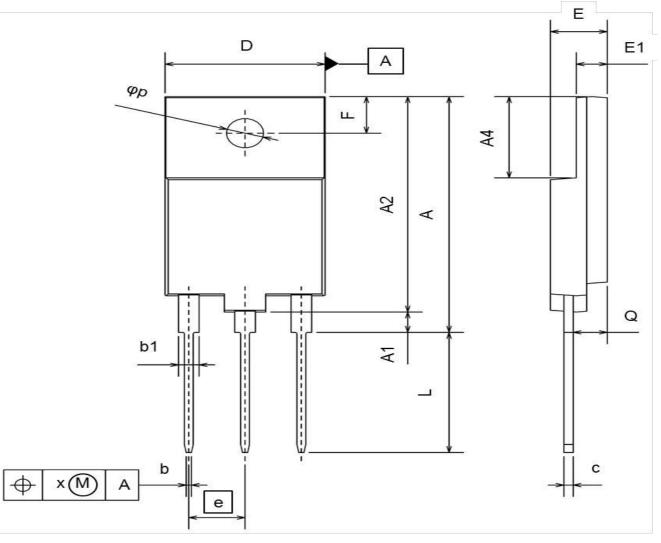
## Fig.3-2 Avalanche Waveform



#### Fig.4-2 trr Waveform



#### Dimensions



| DIM | MILIMETERS |       | INCH  | HES   |
|-----|------------|-------|-------|-------|
|     | MIN        | MAX   | MIN   | MAX   |
| A   | 28.60      | 29.40 | 1.126 | 1.157 |
| A1  | 2.30       | 2.70  | 0.091 | 0.106 |
| A2  | 26.30      | 26.70 | 1.035 | 1.051 |
| A4  | 9.80       | 10.20 | 0.386 | 0.402 |
| b   | 0.66       | 0.95  | 0.026 | 0.037 |
| b1  | 1.80       | 2.20  | 0.071 | 0.087 |
| С   | 0.80       | 1.00  | 0.031 | 0.039 |
| D   | 15.30      | 15.70 | 0.602 | 0.618 |
| E   | 5.30       | 5.70  | 0.209 | 0.224 |
| E1  | 2.80       | 3.20  | 0.110 | 0.126 |
| е   | 5.         | 45    | 0.2   | 15    |
| F   | 4.35       | 4.65  | 0.171 | 0.183 |
| L   | 14.60      | 15.00 | 0.575 | 0.591 |
| φp  | 3.40       | 3.80  | 0.134 | 0.150 |
| Q   | 3.10       | 3.50  | 0.122 | 0.138 |
| Х   | -          | 0.50  |       | 0.020 |

# Dimension in mm / inches

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| (Note1) Medical Equipment Classification of the Specific Applications |
|---|
|---|

| JAPAN  | USA      | EU         | CHINA   |
|--------|----------|------------|---------|
| CLASSⅢ | CLASSⅢ   | CLASS II b | CLASSII |
| CLASSⅣ | CLASSIII | CLASSⅢ     | CLASSI  |

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  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

#### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
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  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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